## Amendment of the Claims

Following is list of claims currently pending.

## 1. -9. (Cancelled)

10. (Currently Amended) A method for patterning structures on a substrate, comprising: providing a substrate underneath a tip of an Atomic Force Microscope:

providing a vapour of a material, which is suitable for Chemical Vapour Deposition onto the substrate when decomposed, in a space between the tip and the substrate; and

exposing the tip to a light beam emitted by a light emitting device in such a way that the tip intensifies an electromagnetic near-field <u>created through a surface Plasmon resonance</u> to such an extent that the vapour is decomposed, wherein an intensity of the light beam <u>at the tip of the Atomic Force Microscope</u> is not enough to decompose the vapour.

- 11. (Currently Amended) A method according to claim 10, wherein providing said vapour comprises providing a gas selected from <u>a\_the\_group</u> consisting of Halides, Hydrides, Metal Organic Compounds, AuClPF<sub>3</sub>, W(CO)<sub>6</sub>, TiCl<sub>4</sub>, TaCl<sub>5</sub>, WF<sub>6</sub>, SiH<sub>4</sub>, GeH<sub>4</sub>, AlH<sub>3</sub>(NMe<sub>3</sub>)<sub>2</sub>, NH<sub>3</sub>, AlMe<sub>2</sub>, Ti(CH<sub>2</sub>tBu)<sub>4</sub>, Ti(OiPr)<sub>4</sub>, Ti(NMe<sub>2</sub>)<sub>4</sub>, Cu(acac)<sub>2</sub>, and Ni(CO)<sub>4</sub>.
- 12. (Original) A method according to claim 10, wherein exposing said tip to said light beam comprises emitting said light beam onto said tip in such a way that a polarization of said light beam is parallel to a longitudinal axis of said tip.

- 13. (Original) A method according to claim 10, further comprising adapting a wavelength of said light beam to match the size of said tip such that a sufficient amplification of said light beam is achieved.
- 14. (Original) A method according to claim 10, further comprising applying a laser to emit said light beam and exposing said tip to said light beam.
- 15. (Original) A method according to claim 10, wherein said Atomic Force Microscope has multiple tips, further comprising providing said substrate underneath said multiple tips.
- 16. (Original) A method according to claim 15, further comprising metalizing one or more of said multiple tips.